## LMD18245 3A, 55V DMOS Full-Bridge Motor Driver

Check for Samples: LMD18245

## FEATURES

- DMOS Power Stage Rated at 55V and 3A Continuous
- Low R $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ of Typically $0.3 \Omega$ per Power Switch
- Internal Clamp Diodes
- Low-loss Current Sensing Method
- Digital or Analog Control of Motor Current
- TTL and CMOS Compatible Inputs
- Thermal Shutdown (Outputs Off) at $\mathrm{T}_{\mathrm{J}}=155^{\circ} \mathrm{C}$
- Overcurrent Protection
- No Shoot-Through Currents
- 15-lead Package


## APPLICATIONS

- Full, Half and Microstep Stepper Motor Drives
- Stepper Motor and Brushed DC Motor Servo Drives
- Automated Factory, Medical and Office Equipment


## DESCRIPTION

The LMD18245 full-bridge power amplifier incorporates all the circuit blocks required to drive and control current in a brushed type DC motor or one phase of a bipolar stepper motor. The multitechnology process used to build the device combines bipolar and CMOS control and protection circuitry with DMOS power switches on the same monolithic structure. The LMD18245 controls the motor current via a fixed off-time chopper technique.
An all DMOS H-bridge power stage delivers continuous output currents up to 3A (6A peak) at supply voltages up to 55 V . The DMOS power switches feature low $\mathrm{R}_{\mathrm{DS}(O \mathrm{O})}$ for high efficiency, and a diode intrinsic to the DMOS body structure eliminates the discrete diodes typically required to clamp bipolar power stages.
An innovative current sensing method eliminates the power loss associated with a sense resistor in series with the motor. A four-bit digital-to-analog converter (DAC) provides a digital path for controlling the motor current, and, by extension, simplifies implementation of full, half and microstep stepper motor drives. For higher resolution applications, an external DAC can be used.

[^0]
## Functional Block and Connection Diagram

15-Lead TO-220 Power Package (NDL)


Figure 1. Functional Block Diagram

## Connection Diagram



Figure 2. Top View
15-Lead Package TO-220 Power Package See Package Number NDL0015A

## Pinout Descriptions

(See Functional Block and Connection Diagrams)
Pin 1, OUT 1: Output node of the first half H -bridge.
Pin 2, COMP OUT: Output of the comparator. If the voltage at CS OUT exceeds that provided by the DAC, the comparator triggers the monostable.
Pin 3, RC: Monostable timing node. A parallel resistorcapacitor network connected between this node and ground sets the monostable timing pulse at about 1.1 RC seconds.
Pin 5, PGND: Ground return node of the power bridge. Bond wires (internal) connect PGND to the tab of the TO-220 package.
Pins 4 and 6 through 8, M4 through M1: Digital inputs of the DAC. These inputs make up a four-bit binary number with M4 as the most significant bit or MSB. The DAC provides an analog voltage directly proportional to the binary number applied at M4 through M1.
Pin 9, $\mathrm{V}_{\mathrm{cc}}$ : Power supply node.
Pin 10, BRAKE: Brake logic input. Pulling the BRAKE input logic-high activates both sourcing switches of the power bridge - effectively shorting the load. See SWITCH CONTROL LOGIC TRUTH TABLE ${ }^{(1)}$. Shorting the load in this manner forces the load current to recirculate and decay to zero.

Pin 11, DIRECTION: Direction logic input. The logic level at this input dictates the direction of current flow in the load. See SWITCH CONTROL LOGIC TRUTH TABLE ${ }^{(1)}$.

Pin 12, SGND: Ground return node of all signal level circuits.
Pin 13, CS OUT: Output of the current sense amplifier. The current sense amplifier sources $250 \mu \mathrm{~A}$ (typical) per ampere of total forward current conducted by the upper two switches of the power bridge.
Pin 14, DAC REF: Voltage reference input of the DAC. The DAC provides an analog voltage equal to $V_{\text {DAC }}$ REF $\times$ $\mathrm{D} / 16$, where D is the decimal equivalent ( $0-15$ ) of the binary number applied at M4 through M1.

Pin 15, OUT 2: Output node of the second half H-bridge.
SWITCH CONTROL LOGIC TRUTH TABLE ${ }^{(1)}$

| BRAKE | DIRECTION | MONO | Active Switches |
| :---: | :---: | :---: | :--- |
| H | X | X | Source 1, Source 2 |
| L | H | L | Source 2 |
| L | H | H | Source 2, Sink 1 |
| L | L | L | Source 1 |
| L | H | Source 1, Sink 2 |  |

(1) $\mathrm{X}=$ don't care. MONO is the output of the monostable.
(1) $\mathrm{X}=$ don't care. MONO is the output of the monostable.

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings ${ }^{(1)(2)}$

| DC Voltage at: |  |
| :---: | :---: |
| OUT 1, $\mathrm{V}_{\mathrm{CC}}$, and OUT 2 | +60V |
| COMP OUT, RC, M4, M3, M2, M1, BRAKE, | +12V |
| DIRECTION, CS OUT, and DAC REF |  |
| DC Voltage PGND to SGND | $\pm 400 \mathrm{mV}$ |
| Continuous Load Current | 3A |
| Peak Load Current ${ }^{(3)}$ | 6A |
| Junction Temperature ( $\mathrm{T}_{\mathrm{J}(\max )}$ ) | $+150^{\circ} \mathrm{C}$ |
| Power Dissipation ${ }^{(4)}$ : |  |
| TO-220 ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, Infinite Heatsink) | 25W |
| TO-220 ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, Free Air) | 3.5 W |
| ESD Susceptibility ${ }^{(5)}$ | 1500V |
| Storage Temperature Range ( $\mathrm{T}_{\mathrm{S}}$ ) | $-40^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 10 seconds) | $300^{\circ} \mathrm{C}$ |

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Electrical specifications do not apply when operating the device outside the rated Operating Conditions.
(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
(3) Unless otherwise stated, load currents are pulses with widths less than 2 ms and duty cycles less than $5 \%$.
(4) The maximum allowable power dissipation at any ambient temperature is $\mathrm{P}_{\mathrm{Max}}=\left(125-\mathrm{T}_{\mathrm{A}}\right) / \theta_{\mathrm{JA}}$, where $125^{\circ} \mathrm{C}$ is the maximum junction temperature for operation, $\mathrm{T}_{\mathrm{A}}$ is the ambient temperature in ${ }^{\circ} \mathrm{C}$, and $\theta_{\mathrm{JA}}$ is the junction-to-ambient thermal resistance in ${ }^{\circ} \mathrm{C} / \mathrm{W}$. Exceeding $P_{\max }$ voids the Electrical Specifications by forcing $T_{j}$ above $125^{\circ} \mathrm{C}$. If the junction temperature exceeds $155^{\circ} \mathrm{C}$, internal circuitry disables the power bridge. When a heatsink is used, $\theta_{\mathrm{JA}}$ is the sum of the junction-to-case thermal resistance of the package, $\theta_{\mathrm{JC}}$, and the case-to-ambient thermal resistance of the heatsink.
(5) ESD rating is based on the human body model of 100 pF discharged through a $1.5 \mathrm{k} \Omega$ resistor. $\mathrm{M} 1, \mathrm{M} 2, \mathrm{M} 3$ and M 4 , pins $8,7,6$ and 4 are protected to 800 V .

Operating Conditions ${ }^{(1)}$

| Temperature Range $\left(T_{J}\right)^{(2)}$ | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| :--- | ---: |
| Supply Voltage Range $\left(\mathrm{V}_{\mathrm{CC}}\right)$ | +12 V to +55 V |
| CS OUT Voltage Range | 0 V to +5 V |
| DAC REF Voltage Range | 0 V to +5 V |
| MONOSTABLE Pulse Range | $10 \mu \mathrm{~s}$ to 100 ms |

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Electrical specifications do not apply when operating the device outside the rated Operating Conditions.
(2) The maximum allowable power dissipation at any ambient temperature is $\mathrm{P}_{\mathrm{Max}}=\left(125-\mathrm{T}_{\mathrm{A}}\right) / \theta_{\mathrm{JA}}$, where $125^{\circ} \mathrm{C}$ is the maximum junction temperature for operation, $\mathrm{T}_{\mathrm{A}}$ is the ambient temperature in ${ }^{\circ} \mathrm{C}$, and $\theta_{\mathrm{JA}}$ is the junction-to-ambient thermal resistance in ${ }^{\circ} \mathrm{C} / \mathrm{W}$. Exceeding $P_{\max }$ voids the Electrical Specifications by forcing $T_{j}$ above $125^{\circ} \mathrm{C}$. If the junction temperature exceeds $155^{\circ} \mathrm{C}$, internal circuitry disables the power bridge. When a heatsink is used, $\theta_{\mathrm{JA}}$ is the sum of the junction-to-case thermal resistance of the package, $\theta_{\mathrm{JC}}$, and the case-to-ambient thermal resistance of the heatsink.

## Electrical Characteristics ${ }^{(1)}$

The following specifications apply for $\mathrm{V}_{\mathrm{CC}}=+42 \mathrm{~V}$, unless otherwise stated. Boldface limits apply over the operating temperature range, $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\boldsymbol{J}} \leq+125^{\circ} \mathrm{C}$. All other limits apply for $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{J}=25^{\circ} \mathrm{C}$.

| Symbol | Parameter | Conditions | Typical ${ }^{(2)}$ | Limit ${ }^{(2)}$ | $\begin{gathered} \begin{array}{c} \text { Units } \\ \text { (Limits) } \end{array} \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ICC | Quiescent Supply Current | DAC REF $=0 \mathrm{~V}, \mathrm{~V}_{\text {CC }}=+20 \mathrm{~V}$ | 8 | 15 | $\begin{gathered} \mathrm{mA} \\ \mathrm{~mA}(\max ) \end{gathered}$ |
| POWER OUTPUT STAGE |  |  |  |  |  |
| $\mathrm{R}_{\mathrm{DS} \text { (ON) }}$ | Switch ON Resistance | $\begin{aligned} & I_{\text {LOAD }}=3 A \\ & I_{\text {LOAD }}=6 A \end{aligned}$ | $\begin{aligned} & 0.3 \\ & 0.3 \end{aligned}$ | $\begin{aligned} & \hline 0.4 \\ & 0.6 \\ & 0.4 \\ & 0.6 \end{aligned}$ | $\Omega(\max )$ <br> $\Omega(\max )$ <br> $\Omega(\max )$ <br> $\Omega$ (max) |
| $V_{\text {DIODE }}$ | Body Diode Forward Voltage | $\mathrm{I}_{\text {DIODE }}=3 \mathrm{~A}$ | 1.0 | 1.5 | $\begin{gathered} \mathrm{V} \\ \mathrm{~V}(\max ) \end{gathered}$ |
| $\mathrm{T}_{\text {rr }}$ | Diode Reverse Recovery Time | $\mathrm{I}_{\text {DIODE }}=1 \mathrm{~A}$ | 80 |  | ns |
| $\mathrm{Q}_{\mathrm{rr}}$ | Diode Reverse Recovery Charge | $\mathrm{I}_{\text {DIODE }}=1 \mathrm{~A}$ | 40 |  | nC |
| $\mathrm{t}_{\mathrm{D}(\mathrm{ON})}$ | Output Turn ON Delay Time <br> Sourcing Outputs <br> Sinking Outputs | $\begin{aligned} & I_{\text {LOAD }}=3 A \\ & I_{\text {LOAD }}=3 A \end{aligned}$ | $\begin{gathered} 5 \\ 900 \end{gathered}$ |  | $\begin{aligned} & \mu \mathrm{s} \\ & \mathrm{~ns} \end{aligned}$ |
| $\mathrm{t}_{\text {( } \mathrm{OFF})}$ | Output Turn OFF Delay Time <br> Sourcing Outputs <br> Sinking Outputs | $\begin{aligned} & I_{\text {LOAD }}=3 A \\ & I_{\text {LOAD }}=3 A \end{aligned}$ | $\begin{aligned} & 600 \\ & 400 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ |
| ton | Output Turn ON Switching Time <br> Sourcing Outputs <br> Sinking Outputs | $\begin{aligned} & I_{\text {LOAD }}=3 A \\ & I_{\text {LOAD }}=3 A \end{aligned}$ | $\begin{gathered} 40 \\ 1 \end{gathered}$ |  | $\begin{aligned} & \mu \mathrm{s} \\ & \mu \mathrm{~s} \end{aligned}$ |
| toff | Output Turn OFF Switching Time <br> Sourcing Outputs <br> Sinking Outputs | $\begin{aligned} & I_{\text {LOAD }}=3 A \\ & I_{\text {LOAD }}=3 A \end{aligned}$ | $\begin{gathered} 200 \\ 80 \end{gathered}$ |  | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ |
| $\mathrm{t}_{\mathrm{pw}}$ | Minimum Input Pulse Width | Pins 10 and 11 | 2 |  | $\mu \mathrm{s}$ |
| $t_{\text {DB }}$ | Minimum Dead Band | (3) | 40 |  | ns |
| CURRENT SENSE AMPLIFIER |  |  |  |  |  |
|  | Current Sense Output | $\mathrm{I}_{\text {LOAD }}=1 \mathrm{~A}^{(4)}$ | 250 | $\begin{aligned} & 200 \\ & 175 \\ & 300 \\ & 325 \end{aligned}$ | $\mu \mathrm{A}$ (min) <br> $\mu \mathrm{A}$ (min) <br> $\mu \mathrm{A}$ (max) <br> $\mu \mathrm{A}(\max )$ |
|  | Current Sense Linearity Error | $0.5 \mathrm{~A} \leq \mathrm{I}_{\text {LOAD }} \leq 3{ }^{(4)}$ | $\pm 6$ | $\pm 9$ | \%(max) |
|  | Current Sense Offset | $\mathrm{I}_{\text {LOAD }}=0 \mathrm{~A}$ | 5 | 20 | $\begin{gathered} \mu \mathrm{A} \\ \mu \mathrm{~A}(\max ) \end{gathered}$ |

(1) Unless otherwise stated, load currents are pulses with widths less than 2 ms and duty cycles less than $5 \%$.
(2) All limits are $100 \%$ production tested at $25^{\circ} \mathrm{C}$. Temperature extreme limits are ensured via correlation using accepted SQC (Statistical Quality Control) methods. All limits are used to calculate AOQL (Average Outgoing Quality Level). Typicals are at $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$ and represent the most likely parametric norm.
(3) Asymmetric turn OFF and ON delay times and switching times ensure a switch turns OFF before the other switch in the same half H bridge begins to turn ON (preventing momentary short circuits between the power supply and ground). The transitional period during which both switches are OFF is commonly referred to as the dead band.
(4) ( $\mathrm{L}_{\text {LOAD }}, \mathrm{I}_{\text {SENSE }}$ ) data points are taken for load currents of $0.5 \mathrm{~A}, 1 \mathrm{~A}, 2 \mathrm{~A}$ and 3 A . The current sense gain is specified as $\mathrm{I}_{\text {SENSE }} / /_{\text {LOAD }}$ for the 1 A data point. The current sense linearity is specified as the slope of the line between the 0.5 A and 1 A data points minus the slope of the line between the 2 A and 3 A data points all divided by the slope of the line between the 0.5 A and 1 A data points.

## Electrical Characteristics ${ }^{(1)}$ (continued)

The following specifications apply for $\mathrm{V}_{\mathrm{CC}}=+42 \mathrm{~V}$, unless otherwise stated. Boldface limits apply over the operating temperature range, $\mathbf{- 4 0 ^ { \circ }} \mathrm{C} \leq \mathrm{T}_{J} \leq+125^{\circ} \mathrm{C}$. All other limits apply for $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{J}=25^{\circ} \mathrm{C}$.

| Symbol | Parameter | Conditions | Typical ${ }^{(2)}$ | Limit ${ }^{(2)}$ | Units (Limits) |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DIGITAL-TO-ANALOG CONVERTER (DAC) |  |  |  |  |  |
|  | Resolution |  |  | 4 | Bits (min) |
|  | Monotonicity |  |  | 4 | Bits (min) |
|  | Total Unadjusted Error |  | 0.125 | $\begin{gathered} 0.25 \\ 0.5 \\ \hline \end{gathered}$ | $\begin{aligned} & \text { LSB (max) } \\ & \text { LSB (max) } \end{aligned}$ |
|  | Propagation Delay |  | 50 |  | ns |
| $\mathrm{I}_{\text {REF }}$ | DAC REF Input Current | DAC REF $=+5 \mathrm{~V}$ | -0.5 | $\pm 10$ | $\mu \mathrm{A}$ <br> $\mu \mathrm{A}(\max )$ |
| COMPARATOR AND MONOSTABLE |  |  |  |  |  |
|  | Comparator High Output Level |  | 6.27 |  | V |
|  | Comparator Low Output Level |  | 88 |  | mV |
|  | Comparator Output Current <br> Source <br> Sink |  | $\begin{aligned} & 0.2 \\ & 3.2 \end{aligned}$ |  | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |
| $t_{\text {DELAY }}$ | Monostable Turn OFF Delay | (5) | 1.2 | 2.0 | $\mu \mathrm{s}$ $\mu \mathrm{s}$ (max) |

## PROTECTION AND PACKAGE THERMAL RESISTANCES

|  | Undervoltage Lockout, $\mathrm{V}_{\text {CC }}$ |  |  | $5$ | $\begin{aligned} & \mathrm{V}(\min ) \\ & \mathrm{V}(\max ) \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {JSD }}$ | Shutdown Temperature, $\mathrm{T}_{\mathrm{J}}$ <br> Package Thermal Resistances |  | 155 |  | ${ }^{\circ} \mathrm{C}$ |
| $\begin{aligned} & \theta_{\mathrm{JC}} \\ & \theta_{\mathrm{JA}} \end{aligned}$ | Junction-to-Case, TO-220 Junction-to-Ambient, TO-220 |  | $\begin{aligned} & 1.5 \\ & 35 \end{aligned}$ |  | $\begin{aligned} & { }^{\circ} \mathrm{C} / \mathrm{W} \\ & { }^{\circ} \mathrm{C} / \mathrm{W} \end{aligned}$ |
| LOGIC INPUTS |  |  |  |  |  |
| $\mathrm{V}_{\text {IL }}$ | Low Level Input Voltage |  |  | $\begin{gathered} -0.1 \\ 0.8 \end{gathered}$ | $\begin{aligned} & \mathrm{V}(\min ) \\ & \mathrm{V}(\max ) \end{aligned}$ |
| $\mathrm{V}_{\mathrm{IH}}$ | High Level Input Voltage |  |  | $\begin{gathered} 2 \\ 12 \end{gathered}$ | $V$ (min) <br> V (max) |
| $\mathrm{I}_{\mathrm{N}}$ | Input Current | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ or 12 V |  | $\pm 10$ | $\mu \mathrm{A}$ (max) |

(5) Turn OFF delay, $\mathrm{t}_{\text {DELAY }}$, is defined as the time from the voltage at the output of the current sense amplifier reaching the DAC output voltage to the lower DMOS switch beginning to turn OFF. With $\mathrm{V}_{\mathrm{CC}}=32 \mathrm{~V}$, DIRECTION high, and $200 \Omega$ connected between OUT1 and $\mathrm{V}_{\mathrm{CC}}$, the voltage at RC is increased from 0 V to 5 V at $1.2 \mathrm{~V} / \mu \mathrm{s}$, and $\mathrm{t}_{\mathrm{DELAY}}$ is measured as the time from the voltage at RC reaching 2 V to the time the voltage at OUT 1 reaches 3 V .

## Typical Performance Characteristics



JUNCTION TEMPERATURE ( ${ }^{\circ} \mathrm{C}$ )
Figure 3.


Figure 5.


Figure 7.


Figure 4.


Figure 6.


Figure 8.

## FUNCTIONAL DESCRIPTIONS

## TYPICAL OPERATION OF A CHOPPER AMPLIFIER

Chopper amplifiers employ feedback driven switching of a power bridge to control and limit current in the winding of a motor (Figure 9). The bridge consists of four solid state power switches and four diodes connected in an H configuration. Control circuitry (not shown) monitors the winding current and compares it to a threshold. While the winding current remains less than the threshold, a source switch and a sink switch in opposite halves of the bridge force the supply voltage across the winding, and the winding current increases rapidly towards $\mathrm{V}_{\mathrm{CC}} / \mathrm{R}$ (Figure 9a and Figure 9d). As the winding current surpasses the threshold, the control circuitry turns OFF the sink switch for a fixed period or off-time. During the off-time, the source switch and the opposite upper diode short the winding, and the winding current recirculates and decays slowly towards zero (Figure $9 b$ and Figure $9 e$ ). At the end of the off-time, the control circuitry turns back ON the sink switch, and the winding current again increases rapidly towards $\mathrm{V}_{\mathrm{CC}} / \mathrm{R}$ (Figure $9 a$ and Figure 9dagain). The above sequence repeats to provide a current chopping action that limits the winding current to the threshold (Figure 9g). Chopping only occurs if the winding current reaches the threshold. During a change in the direction of the winding current, the diodes provide a decay path for the initial winding current (Figure 9c and Figure 9f). Since the bridge shorts the winding for a fixed period, this type of chopper amplifier is commonly referred to as a fixed off-time chopper.



Figure 9. Chopper Amplifier Chopping States: Full $\mathrm{V}_{\mathrm{cc}}$ Applied Across the Winding (a) and (d), Shorted Winding (b) and (e), Winding Current Decays During a Change in the Direction of the Winding Current (c) and (f), and the Chopped Winding Current (g)

## THE LMD18245 CHOPPER AMPLIFIER

The LMD18245 incorporates all the circuit blocks needed to implement a fixed off-time chopper amplifier. These blocks include: an all DMOS, full H-bridge with clamp diodes, an amplifier for sensing the load current, a comparator, a monostable, and a DAC for digital control of the chopping threshold. Also incorporated are logic, level shifting and drive blocks for digital control of the direction of the load current and braking.

## THE H-BRIDGE

The power stage consists of four DMOS power switches and associated body diodes connected in an H -bridge configuration (Figure 10 ).
The time constant to charge or discharge any inductor, in this case the motor windings, is defined as:
$T=L / R$
where

- $L$ is the winding inductance
- R is the sum of the series resistance in the current path including the winding resistance

Turning ON a source switch and a sink switch in opposite halves of the bridge forces the full supply voltage less the switch drops ( $\left(\times R_{\text {DS(ON) }}\right)$ across the motor winding. While the bridge remains in this state, the winding current increases exponentially towards a limit dictated by the supply voltage, the switch drops ( $1 \times \mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ ), and the winding resistance. However, the winding current exponential rate of increase will end when the current chopping circuitry becomes active.

Subsequently turning OFF the sink switch causes a voltage transient that forward biases the body diode of the other source switch. The diode clamps the transient at one diode drop above the supply voltage and provides an alternative current path. While the bridge remains in this state, it essentially shorts the winding, the winding current recirculates and decays exponentially towards zero at a rate that is defined by the L/R time constant.

During a change in the direction of the winding current, both the switches and the body diodes provide a decay path for the initial winding current (Figure 11).

During actual motor operation there are many variables that can effect the motor winding magnetic behavior and performance. Resonance, eddy currents, friction, motor loading, damping, temperature coefficients of the windings, are only a few. These are all issues that are beyond the scope of the this data sheet.


Figure 10. The DMOS H-Bridge


Figure 11. Decay Paths for Initial Winding Current During a Change in the Direction of the Winding Current

## THE CURRENT SENSE AMPLIFIER

Many transistor cells in parallel make up the DMOS power switches. The current sense amplifier (Figure 12) uses a small fraction of the cells of both upper switches to provide a unique, low-loss means for sensing the load current. In practice, each upper switch functions as a $1 x$ sense device in parallel with a 4000 x power device. The current sense amplifier forces the voltage at the source of the sense device to equal that at the source of the power device; thus, the devices share the total drain current in proportion to the 1:4000 cell ratio. Only the current flowing from drain to source, the forward current, registers at the output of the current sense amplifier. The current sense amplifier, therefore, sources $250 \mu \mathrm{~A}$ per ampere of total forward current conducted by the upper two switches of the power bridge.
The sense current develops a potential across $\mathrm{R}_{\mathrm{s}}$ that is proportional to the load current; for example, per ampere of load current, the sense current develops one volt across a $4 \mathrm{k} \Omega$ resistor (the product of $250 \mu \mathrm{~A}$ per ampere and $4 \mathrm{k} \Omega$ ). Since chopping of the load current occurs as the voltage at CS OUT surpasses the threshold (the DAC output voltage), $\mathrm{R}_{\mathrm{S}}$ sets the gain of the chopper amplifier; for example, a $2 \mathrm{k} \Omega$ resistor sets the gain at two amperes of load current per volt of the threshold (the reciprocal of the product of $250 \mu \mathrm{~A}$ per ampere and $2 \mathrm{k} \Omega$ ). A quarter watt resistor suffices. A low value capacitor connected in parallel with $R_{S}$ filters the effects of switching noise from the current sense signal.
While the specified maximum DC voltage compliance at CS OUT is 12 V , the specified operating voltage range at CS OUT is 0 V to 5 V .

## THE DIGITAL-TO-ANALOG CONVERTER (DAC)

The DAC sets the threshold voltage for chopping at $\mathrm{V}_{\text {DAC REF }} \times \mathrm{D} / 16$, where D is the decimal equivalent (0-15) of the binary number applied at M4 through M1, the digital inputs of the DAC. M4 is the MSB or most significant bit. For applications that require higher resolution, an external DAC can drive the DAC REF input. While the specified maximum DC voltage compliance at DAC REF is 12 V , the specified operating voltage range at DAC REF is 0 V to 5 V .

## THE COMPARATOR, MONOSTABLE AND WINDING CURRENT THRESHOLD FOR CHOPPING

As the voltage at CS OUT surpasses that at the output of the DAC, the comparator triggers the monostable, and the monostable, once triggered, provides a timing pulse to the control logic. During the timing pulse, the power bridge shorts the motor winding, causing current in the winding to recirculate and decay slowly towards zero (Figure $9 b$ and Figure $9 e$ again). A parallel resistor-capacitor network connected between RC (pin \#3) and ground sets the timing pulse or off-time at about 1.1 RC seconds.
Chopping of the winding current occurs as the voltage at CS OUT exceeds that at the output of the DAC; so chopping occurs at a winding current threshold of about

$$
\begin{equation*}
\left.\left(V_{\text {DAC REF }} \times \mathrm{D} / 16\right) \div\left(\left(250 \times 10^{-6}\right) \times \mathrm{R}_{\mathrm{S}}\right)\right) \text { amperes. } \tag{2}
\end{equation*}
$$

The $R_{S}$ value required to set the winding current threshold at the maximum rated current of the LMD18245, with $\mathrm{D}=15$ and $\mathrm{V}_{\text {DAC REF }}$ of 5.00 V would be:

$$
\begin{equation*}
\left.(5.00 \mathrm{~V} \times 15 / 16) \div\left(\left(250 \times 10^{-6}\right) \times 6.25 \mathrm{k} \Omega\right)\right)=3.00 \mathrm{~A} \tag{3}
\end{equation*}
$$

The resulting typical DAC programmable current limit values, for different values of $R_{S}$, would be:
Table 1. D to A winding current thresholds for $\mathrm{V}_{\text {REF }} \mathrm{DAC}=5.00 \mathrm{~V}$

| $\mathbf{D}$ | $\mathbf{R}_{\mathbf{S}}=$ <br> $\mathbf{1 8 . 7 5 \mathbf { k } \boldsymbol { \Omega }}$ | $\mathbf{R}_{\mathbf{S}}=$ <br> $\mathbf{9 . 3 7 5} \boldsymbol{\mathbf { R }}$ | $\mathbf{R}_{\mathbf{S}}=$ <br> $\mathbf{6 . 2 5 0} \mathbf{k} \boldsymbol{\Omega}$ |
| :---: | :---: | :---: | :---: |
| 0 | 0.00 A | 0.00 A | 0.00 A |
| 1 | 0.07 A | 0.13 A | 0.20 A |
| 2 | 0.13 A | 0.27 A | 0.40 A |
| 3 | 0.20 A | 0.40 A | 0.60 A |
| 4 | 0.27 A | 0.53 A | 0.80 A |
| 5 | 0.33 A | 0.67 A | 1.00 A |
| 6 | 0.40 A | 0.80 A | 1.20 A |
| 7 | 0.47 A | 0.93 A | 1.40 A |
| 8 | 0.53 A | 1.07 A | 1.60 A |
| 9 | 0.60 A | 1.20 A | 1.80 A |
| 10 | 0.67 A | 1.33 A | 2.00 A |
| 11 | 0.73 A | 1.47 A | 2.20 A |
| 12 | 0.80 A | 1.60 A | 2.40 A |
| 13 | 0.87 A | 1.73 A | 2.60 A |
| 14 | 0.93 A | 1.87 A | 2.80 A |
| 15 | 1.00 A | 2.00 A | 3.00 A |



Figure 12. The Source Switches of the Power Bridge and the Current Sense Amplifier

## Applications Information

## POWER SUPPLY BYPASSING

Step changes in current drawn from the power supply occur repeatedly during normal operation and may cause large voltage spikes across inductance in the power supply line. Care must be taken to limit voltage spikes at $\mathrm{V}_{\mathrm{CC}}$ to less than the 60 V Absolute Maximum Rating. At a change in the direction of the load current, the initial load current tends to raise the voltage at the power supply rail (Figure 11) again. Current transients caused by the reverse recovery of the clamp diodes tend to pull down the voltage at the power supply rail.
Bypassing the power supply line at $\mathrm{V}_{\mathrm{CC}}$ is required to protect the device and minimize the adverse effects of normal operation on the power supply rail. Using both a $1 \mu \mathrm{~F}$ high frequency ceramic capacitor and a large-value aluminum electrolytic capacitor is highly recommended. A value of $100 \mu \mathrm{~F}$ per ampere of load current usually suffices for the aluminum electrolytic capacitor. Both capacitors should have short leads and be located within one half inch of $\mathrm{V}_{\mathrm{Cc}}$.

## OVERCURRENT PROTECTION

If the forward current in either source switch exceeds a 12A threshold, internal circuitry disables both source switches, forcing a rapid decay of the fault current (Figure 13). Approximately $3 \mu \mathrm{~s}$ after the fault current reaches zero, the device restarts. Automatic restart allows an immediate return to normal operation once the fault condition has been removed. If the fault persists, the device will begin cycling into and out of thermal shutdown. Switching large fault currents may cause potentially destructive voltage spikes across inductance in the power supply line; therefore, the power supply line must be properly bypassed at $\mathrm{V}_{\mathrm{C}}$ for the motor driver to survive an extended overcurrent fault.

In the case of a locked rotor, the inductance of the winding tends to limit the rate of change of the fault current to a value easily handled by the protection circuitry. In the case of a low inductance short from either output to ground or between outputs, the fault current could surge past the 12A shutdown threshold, forcing the device to dissipate a substantial amount of power for the brief period required to disable the source switches. Because the fault power must be dissipated by only one source switch, a short from output to ground represents the worst case fault. Any overcurrent fault is potentially destructive, especially while operating with high supply voltages $(\geq 30 \mathrm{~V})$, so precautions are in order. Sinking $\mathrm{V}_{\mathrm{CC}}$ for heat with 1 square inch of 1 ounce copper on the printed circuit board is highly recommended. The sink switches are not internally protected against shorts to $\mathrm{V}_{\mathrm{Cc}}$.

## THERMAL SHUTDOWN

Internal circuitry senses the junction temperature near the power bridge and disables the bridge if the junction temperature exceeds about $155^{\circ} \mathrm{C}$. When the junction temperature cools past the shutdown threshold (lowered by a slight hysteresis), the device automatically restarts.

## UNDERVOLTAGE LOCKOUT

Internal circuitry disables the power bridge if the power supply voltage drops below a rough threshold between 8 V and 5 V . Should the power supply voltage then exceed the threshold, the device automatically restarts.


Trace: Fault Current at 5A/div
Horizontal: $20 \mu \mathrm{~s} / \mathrm{div}$
Figure 13. Fault Current with $\mathrm{V}_{\mathrm{cc}}=30 \mathrm{~V}$, OUT 1 Shorted to OUT 2, and CS OUT Grounded

## The Typical Application

Figure 14 shows the typical application, the power stage of a chopper drive for bipolar stepper motors. The 20 $\mathrm{k} \Omega$ resistor and 2.2 nF capacitor connected between RC and ground set the off-time at about $48 \mu \mathrm{~s}$, and the 20 $\mathrm{k} \Omega$ resistor connected between CS OUT and ground sets the gain at about 200 mA per volt of the threshold for chopping. Digital signals control the thresholds for chopping, the directions of the winding currents, and, by extension, the drive type (full step, half step, etc.). A pprocessor or $\mu$ controller usually provides the digital control signals.


Figure 14. Typical Application Circuit for Driving Bipolar Stepper Motors

## ONE-PHASE-ON FULL STEP DRIVE (WAVE DRIVE)

To make the motor take full steps, windings $A$ and $B$ can be energized in the sequence

$$
\mathrm{A} \rightarrow \mathrm{~B} \rightarrow \mathrm{~A}^{*} \rightarrow \mathrm{~B}^{*} \rightarrow \mathrm{~A} \rightarrow \ldots,
$$

where $A$ represents winding $A$ energized with current in one direction and $A^{*}$ represents winding $A$ energized with current in the opposite direction. The motor takes one full step each time one winding is de-energized and the other is energized. To make the motor step in the opposite direction, the order of the above sequence must be reversed. Figure 15 shows the winding currents and digital control signals for a wave drive application of the typical application circuit.

## TWO-PHASE-ON FULL STEP DRIVE

To make the motor take full steps, windings $A$ and $B$ can also be energized in the sequence

$$
\mathrm{AB} \rightarrow \mathrm{~A}^{*} \mathrm{~B} \rightarrow \mathrm{~A}^{*} \mathrm{~B}^{*} \rightarrow \mathrm{AB}^{*} \rightarrow \mathrm{AB} \rightarrow \ldots
$$

and because both windings are energized at all times, this sequence produces more torque than that produced with wave drive. The motor takes one full step at each change of direction of either winding current. Figure 16 shows the winding currents and digital control signals for this application of the typical application circuit, and Figure 17 shows, for a single phase, the winding current and voltage at the output of the associated current sense amplifier.


Top Trace: Phase A Winding Current at $1 \mathrm{~A} /$ div
Bottom Trace: Phase B Winding Current at 1A/div
Horizontal: $1 \mathrm{~ms} /$ div
*500 steps/second


BRAKE $A=B R A K E B=0$
Figure 15. Winding Currents and Digital Control Signals for One-Phase-On Drive (Wave Drive)


Top Trace: Phase A Winding Current at 1A/div
Bottom Trace: Phase B Winding Current at 1A/div
Horizontal: $1 \mathrm{~ms} /$ div
*500 steps/second


M4 A through $\mathrm{M} 1 \mathrm{~A}=\mathrm{M} 4 \mathrm{~B}$ through $\mathrm{M} 1 \mathrm{~B}=1$
BRAKE $A=$ BRAKE $B=0$
Figure 16. Winding Currents and Digital Control Signals for Two-Phase-On Drive


Top Trace: Phase A Winding Current at 1A/div
Bottom Trace: Phase A Sense Voltage at 5V/div
Horizontal: $1 \mathrm{~ms} / \mathrm{div}$
*500 steps/second
Figure 17. Winding Current and Voltage at the Output of the Associated Current Sense Amplifier

## HALF STEP DRIVE WITHOUT TORQUE COMPENSATION

To make the motor take half steps, windings $A$ and $B$ can be energized in the sequence

$$
\begin{aligned}
& \mathrm{A} \rightarrow \mathrm{AB} \rightarrow \mathrm{~B} \rightarrow \mathrm{~A}^{*} \mathrm{~B} \rightarrow \mathrm{~A}^{*} \rightarrow \\
& \mathrm{~A}^{*} \mathrm{~B}^{*} \rightarrow \mathrm{~B}^{*} \rightarrow \mathrm{AB}^{*} \rightarrow \mathrm{~A} \rightarrow \ldots
\end{aligned}
$$

The motor takes one half step each time the number of energized windings changes. It is important to note that although half stepping doubles the step resolution, changing the number of energized windings from two to one decreases (one to two increases) torque by about $40 \%$, resulting in significant torque ripple and possibly noisy operation. Figure 18 shows the winding currents and digital control signals for this half step application of the typical application circuit.


Top Trace: Phase A Winding Current at 1A/div
Bottom Trace: Phase B Winding Current at 1A/div
Horizontal: $1 \mathrm{~ms} / \mathrm{div}$
*500 steps/second


BRAKE A $=$ BRAKE $\mathrm{B}=0$
Figure 18. Winding Currents and Digital Control Signals for Half Step Drive without Torque Compensation

## HALF STEP DRIVE WITH TORQUE COMPENSATION

To make the motor take half steps, the windings can also be energized with sinusoidal currents (Figure 19). Controlling the winding currents in the fashion shown doubles the step resolution without the significant torque ripple of the prior drive technique. The motor takes one half step each time the level of either winding current changes. Half step drive with torque compensation is microstepping drive. Along with the obvious advantage of increased step resolution, micro-stepping reduces both full step oscillations and resonances that occur as the motor and load combination is driven at its natural resonant frequency or subharmonics thereof. Both of these advantages are obtained by replacing full steps with bursts of microsteps. When compared to full step drive, the motor runs smoother and quieter.
Table 2 shows the lookup table for this application of the typical application circuit. Dividing $90^{\circ}$ electrical per full step by two microsteps per full step yields $45^{\circ}$ electrical per microstep. a, therefore, increases from 0 to $315^{\circ}$ in increments of $45^{\circ}$. Each full $360^{\circ}$ cycle comprises eight half steps. Rounding |cosa| to four bits gives D A, the decimal equivalent of the binary number applied at M4 A through M1 A. DIRECTION A controls the polarity of the current in winding A. Figure 19 shows the sinusoidal winding currents.


Top Trace: Phase A Winding Current at 1A/div
Bottom Trace: Phase B Winding Current at 1A/div
Horizontal: $2 \mathrm{~ms} /$ div
*500 steps/second


BRAKE $A=$ BRAKE $B=0$
$90^{\circ}$ ELECTRICAL/FULL STEP $\div 2$ MICROSTEPS/FULL STEP $=45^{\circ}$ ELECTRICAL/MICROSTEP
Figure 19. Winding Currents and Digital Control Signals for Half Step Drive with Torque Compensation

Table 2. Lookup Table for Half Step Drive with Torque Compensation

|  | $\alpha$ | \| $\cos (\alpha) \mid$ | D A | DIRECTION A | $\|\boldsymbol{s i n}(\alpha)\|$ | D B | DIRECTION B |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| I | $0^{\circ}$ | 1 | 15 | 1 | 0 | 0 | 1 |
| FORWARD | $45^{\circ}$ | 0.707 | 11 | 1 | 0.707 | 11 | 1 |
| $\downarrow$ | $90^{\circ}$ | 0 | 0 | 0 | 1 | 15 | 1 |
|  | $135^{\circ}$ | 0.707 | 11 | 0 | 0.707 | 11 | 1 |
|  | $180^{\circ}$ | 1 | 15 | 0 | 0 | 0 | 0 |
| $\uparrow$ | $225^{\circ}$ | 0.707 | 11 | 0 | 0.707 | 11 | 0 |
| REVERSE | $270^{\circ}$ | 0 | 0 | 1 | 1 | 15 | 0 |
| \| | $315^{\circ}$ | 0.707 | 11 | 1 | 0.707 | 11 | 0 |
| REPEAT |  |  |  |  |  |  |  |

## QUARTER STEP DRIVE WITH TORQUE COMPENSATION

Figure 20 shows the winding currents and lookup table for a quarter step drive (four microsteps per full step) with torque compensation.


Top Trace: Phase A Winding Current at $1 \mathrm{~A} /$ div
Bottom Trace: Phase B Winding Current at 1A/div
Horizontal: 2ms/div
*250 steps/second
$90^{\circ}$ ELECTRICAL/FULL STEP $\div 4$ MICROSTEPS/FULL STEP $=22.5^{\circ}$ ELECTRICAL/MICROSTEP
Figure 20. Winding Currents for Quarter Step Drive with Torque Compensation

Table 3. Lookup Table for Quarter Step Drive with Torque Compensation ${ }^{(1)}$

| FORWARD | a | \| $\cos (\alpha) \mid$ | D A | DIRECTION A | $\|\boldsymbol{\operatorname { s i n }}(\alpha)\|$ | D B | DIRECTION B |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $0.0^{\circ}$ | 1 | 15 | 1 | 0 | 0 | 1 |
|  | $22.5^{\circ}$ | 0.924 | 14 | 1 | 0.383 | 6 | 1 |
|  | $45.0^{\circ}$ | 0.707 | 11 | 1 | 0.707 | 11 | 1 |
|  | $67.5^{\circ}$ | 0.383 | 6 | 1 | 0.924 | 14 | 1 |
|  | $90.0^{\circ}$ | 0 | 0 | 0 | 1 | 15 | 1 |
|  | $112.5^{\circ}$ | 0.383 | 6 | 0 | 0.924 | 14 | 1 |
|  | $135.0^{\circ}$ | 0.707 | 11 | 0 | 0.707 | 11 | 1 |
|  | $157.5^{\circ}$ | 0.924 | 14 | 0 | 0.383 | 6 | 1 |
|  | $180.0^{\circ}$ | 1 | 15 | 0 | 0 | 0 | 0 |
|  | $202.5^{\circ}$ | 0.924 | 14 | 0 | 0.383 | 6 | 0 |
|  | $225.0^{\circ}$ | 0.707 | 11 | 0 | 0.707 | 11 | 0 |
|  | $247.5^{\circ}$ | 0.383 | 6 | 0 | 0.924 | 14 | 0 |
|  | $270.0^{\circ}$ | 0 | 0 | 1 | 1 | 15 | 0 |
| $\uparrow$ <br> REVERSE <br> \| | $292.5^{\circ}$ | 0.383 | 6 | 1 | 0.924 | 14 | 0 |
|  | $315.0^{\circ}$ | 0.707 | 11 | 1 | 0.707 | 11 | 0 |
|  | $337.5^{\circ}$ | 0.924 | 14 | 1 | 0.383 | 6 | 0 |
|  | REPEAT |  |  |  |  |  |  |

(1) BRAKE A $=$ BRAKE $B=0$

## Test Circuit and Switching Time Definitions



## REVISION HISTORY

- Changed layout of National Data Sheet to TI format ........................................................................................................ 25

INSTRUMENTS

## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead finish/ Ball material (6) | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LMD18245T | LIFEBUY | TO-220 | NDL | 15 | 20 | Non-RoHS \& Green | Call TI | Level-1-NA-UNLIM | -40 to 125 | $\begin{aligned} & \text { LMD18245T } \\ & \text { P+ } \end{aligned}$ |  |
| LMD18245T/NOPB | ACTIVE | TO-220 | NDL | 15 | 20 | RoHS \& Green | SN | Level-1-NA-UNLIM | -40 to 125 | LMD18245T $\mathrm{P}_{+}$ | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: Tl defines "Green" to mean the content of Chlorine (Cl) and Bromine ( Br ) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the $<=1000 \mathrm{ppm}$ threshold requirement.
${ }^{(3)}$ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a " $\sim$ " will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
${ }^{(6)}$ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall Tl's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by Tl to Customer on an annual basis.

## TUBE



B - Alignment groove width
*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T $(\boldsymbol{\mu m})$ | B (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LMD18245T | NDL | TO-220 | 15 | 20 | 502 | 34 | 12192 | 0 |
| LMD18245T | NDL | TO-220 | 15 | 20 | 502 | 34 | 12192 | 0 |
| LMD18245T/NOPB | NDL | TO-220 | 15 | 20 | 502 | 34 | 12192 | 0 |

## NDL0015A



## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.
These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.
These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other Tl intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to Tl's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter Tl's applicable warranties or warranty disclaimers for TI products.
TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2024, Texas Instruments Incorporated


[^0]:    今
    Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

